CJP20N20

POWER FIELD EFFECT TRANSISTOR

GENERAL DESCRIPTION

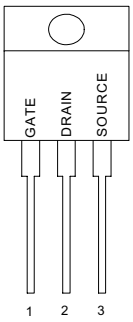
This advanced MOSFET is designed to withstand high energy in avalanche and commutation modes. The new energy efficient design also offers a drain-to-source diode with a fast recovery time. Designed for high voltage, high speed switching applications in power supplies, converters and PWM motor controls, these devices are particularly well suited for bridge circuits where diode speed and commutating safe operating areas are critical and offer additional and safety margin against unexpected voltage transients.

FEATURES

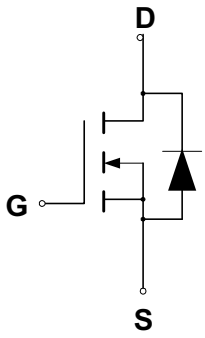
- Avalanche Energy Specified
- Source-to-Drain Diode Recovery Time Comparable to a Discrete Fast Recovery Diode
- Diode is Characterized for Use in Bridge Circuits
- I_{DSS} and V_{DS}(on) Specified at Elevated Temperature

PIN CONFIGURATION

TO-220
Top View



SYMBOL



ABSOLUTE MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Drain to Current — Continuous	I_D	20	A
— Pulsed	I_{DM}	60	
Gate-to-Source Voltage — Continue	V_{GS}	±20	V
— Non-repetitive	V_{GSM}	±40	V
Total Power Dissipation	P_D	125	W
Derate above 25℃		1.00	W/℃
Operating and Storage Temperature Range	T_J, T_{STG}	-55 to 150	℃
Single Pulse Drain-to-Source Avalanche Energy — T_J = 25℃ (V_{DD} = 100V, V_{GS} = 10V, I_L = 20A, L = 10mH, R_G = 25Ω)	E_{AS}	600	mJ
Thermal Resistance — Junction to Case	θ_{JC}	1.00	℃/W
— Junction to Ambient	θ_{JA}	62.5	
Maximum Lead Temperature for Soldering Purposes, 1/8" from case for 10 seconds	T_L	260	℃

ELECTRICAL CHARACTERISTICS

Unless otherwise specified, T_J = 25℃.

Characteristic		Symbol	Min	Typ	Max	Units
Drain-Source Breakdown Voltage (V_{GS} = 0 V, I_D = 250 μA)		$V_{(BR)DSS}$	200			V
Drain-Source Leakage Current (V_{DS} = 200 V, V_{GS} = 0 V)		I_{DSS}			10	μA
(V_{DS} = 200 V, V_{GS} = 0 V, T_J = 125℃)					100	
Gate-Source Leakage Current-Forward (V_{gsf} = 20 V, V_{DS} = 0 V)		I_{GSSF}			100	nA
Gate-Source Leakage Current-Reverse (V_{gsr} = 20 V, V_{DS} = 0 V)		I_{GSSR}			100	nA
Gate Threshold Voltage (V_{DS} = V_{GS}, I_D = 250 μA)		$V_{GS(th)}$	2.0		4.0	V
Static Drain-Source On-Resistance (V_{GS} = 10 V, I_D = 10A) *		$R_{DS(on)}$		0.12	0.16	Ω
Drain-Source On-Voltage (V_{GS} = 10 V) (I_D = 20 A)		$V_{DS(on)}$		3.4	5.9	V
Forward Transconductance (V_{DS} = 13 V, I_D = 10A) *		g_{FS}	8.0	11		S
Input Capacitance	(V_{DS} = 25 V, V_{GS} = 0 V, f = 1.0 MHz)	C_{iss}		1880	2700	pF
Output Capacitance		C_{oss}		378	535	pF
Reverse Transfer Capacitance		C_{rss}		68	100	pF
Turn-On Delay Time	(V_{DD} = 100 V, I_D = 20 A, V_{GS} = 10 V, R_G = 9.1Ω) *	$t_{d(on)}$		17	40	ns
Rise Time		t_r		86	180	ns
Turn-Off Delay Time		$t_{d(off)}$		50	100	ns
Fall Time		t_f		60	120	ns
Total Gate Charge	(V_{DS} = 160 V, I_D = 20 A, V_{GS} = 10 V)*	Q_g		54	75	nC
Gate-Source Charge		Q_{gs}		12		nC
Gate-Drain Charge		Q_{gd}		24		nC
Internal Drain Inductance (Measured from the drain lead 0.25" from package to center of die)		L_D		4.5		nH
Internal Drain Inductance (Measured from the source lead 0.25" from package to source bond pad)		L_S		7.5		nH
SOURCE-DRAIN DIODE CHARACTERISTICS						
Forward On-Voltage(1)	(I_S = 20 A, d_{IS}/d_t = 100A/μs)	V_{SD}		1.0	1.35	V
Forward Turn-On Time		t_{on}		**		ns
Reverse Recovery Time		t_{rr}		239		ns

* Pulse Test: Pulse Width ≦300μs, Duty Cycle ≦2%

** Negligible, Dominated by circuit inductance

TYPICAL ELECTRICAL CHARACTERISTICS

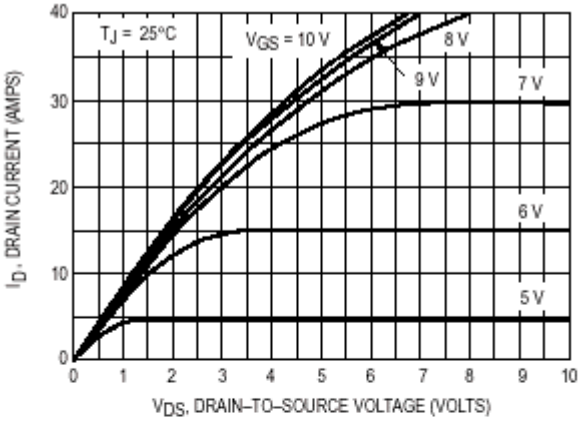


Figure 1. On–Region Characteristics

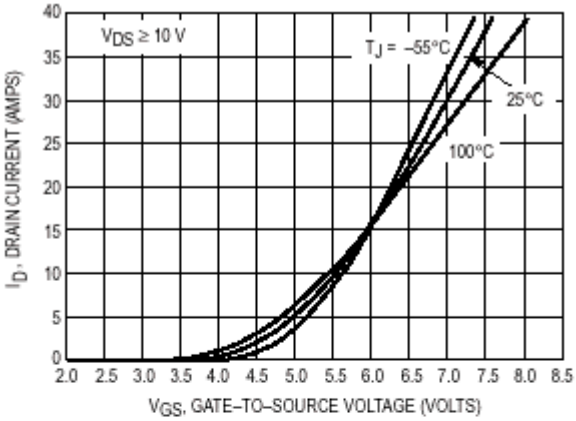


Figure 2. Transfer Characteristics

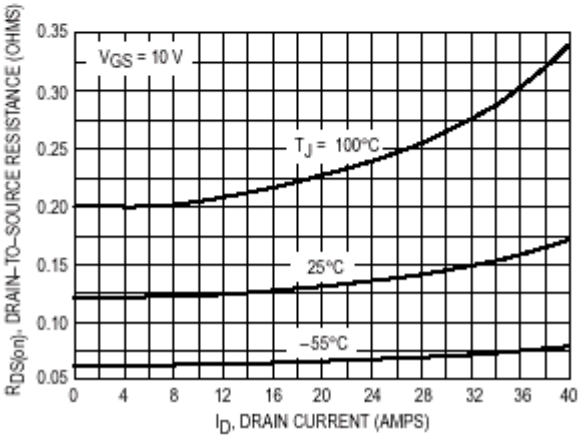


Figure 3. On–Resistance versus Drain Current and Temperature

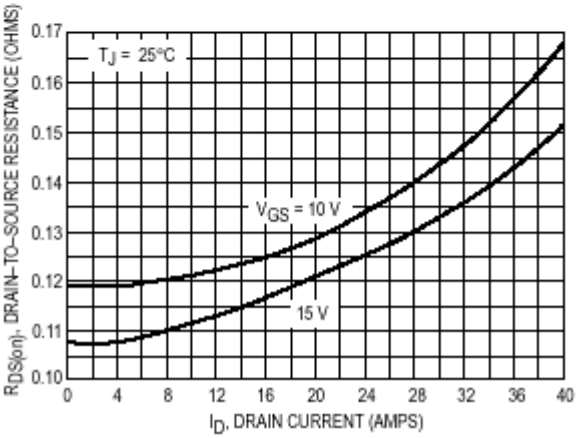


Figure 4. On–Resistance versus Drain Current and Gate Voltage

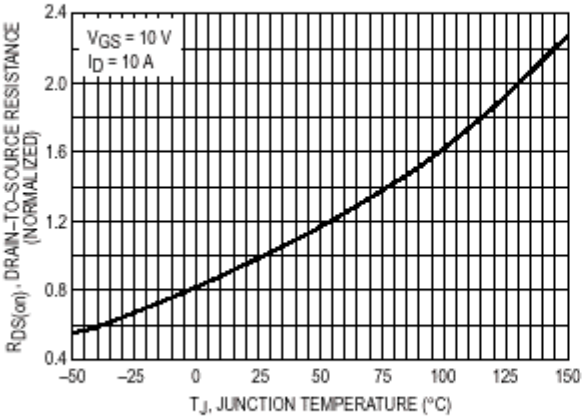


Figure 5. On–Resistance Variation with Temperature

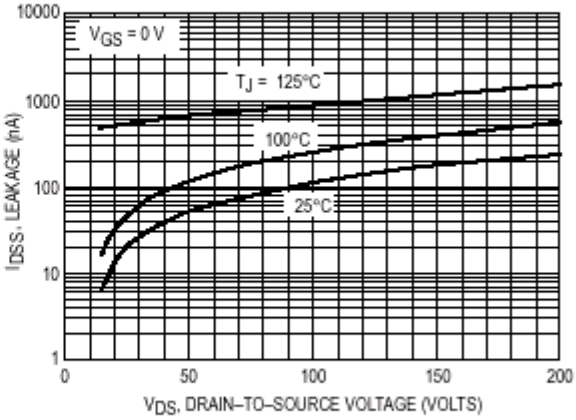
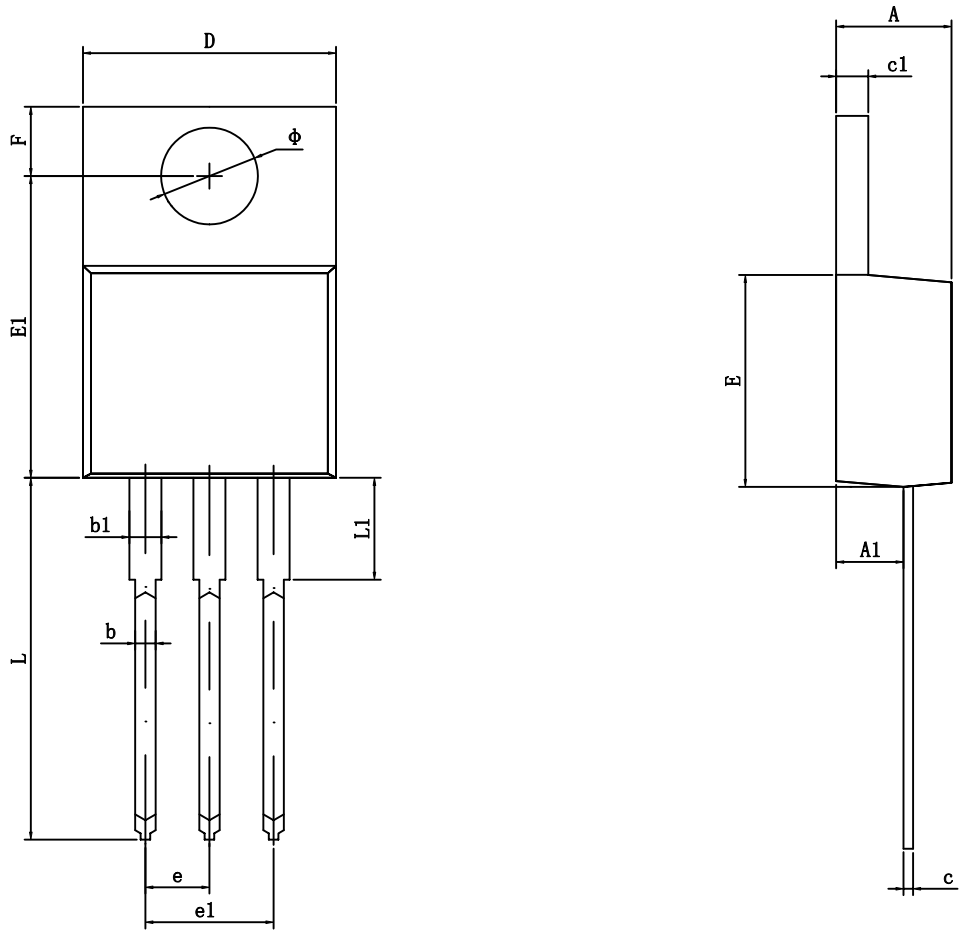


Figure 6. Drain–To–Source Leakage Current versus Voltage

TO-220 PACKAGE OUTLINE DIMENSIONS



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A	4.470	4.670	0.176	0.184
A1	2.520	2.820	0.099	0.111
b	0.710	0.910	0.028	0.036
b1	1.170	1.370	0.046	0.054
c	0.310	0.530	0.012	0.021
c1	1.170	1.370	0.046	0.054
D	10.010	10.310	0.394	0.406
E	8.500	8.900	0.335	0.350
E1	12.060	12.460	0.475	0.491
e	2.540TYP		0.100TYP	
e1	4.980	5.180	0.196	0.204
F	2.590	2.890	0.102	0.114
L	13.400	13.800	0.528	0.543
L1	3.560	3.960	0.140	0.156
Φ	3.790	3.890	0.149	0.153